

## **2N7002BK** 60 V, 350 mA N-channel Trench MOSFET Rev. 1 — 17 June 2010

**Product data sheet** 

## 1. Product profile

### 1.1 General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 1.2 Features and benefits

- Logic-level compatible
- Very fast switching
- Trench MOSFET technology
- ESD protection up to 2 kV
- AEC-Q101 qualified

### **1.3 Applications**

- Relay driver
- High-speed line driver
- Low-side loadswitch
- Switching circuits

### 1.4 Quick reference data

#### Table 1.Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>amb</sub> = 25 °C	-	-	60	V
V <sub>GS</sub>	gate-source voltage	T <sub>amb</sub> = 25 °C	-	-	±20	V
I <sub>D</sub>	drain current	T <sub>amb</sub> = 25 °C; V <sub>GS</sub> = 10 V	[1] -	-	350	mA
R <sub>DSon</sub>	drain-source on-state resistance	T <sub>j</sub> = 25 °C; V <sub>GS</sub> = 10 V; I <sub>D</sub> = 500 mA	-	1	1.6	Ω

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.



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## 2. Pinning information

Table 2.	Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		2
2	S	source		D
3	D	drain	1 2	
				017aaa000

## 3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
2N7002BK	TO-236AB	plastic surface-mounted package; 3 leads	SOT23		

## 4. Marking

Table 4. Marking codes	
Type number	Marking code <sup>[1]</sup>
2N7002BK	LN*
[1] * = -: made in Hong Kong	

- \* = p: made in Hong Kong
- \* = t: made in Malaysia
- \* = W: made in China

## 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

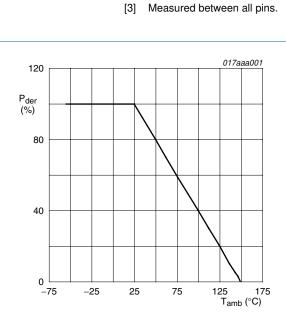
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>amb</sub> = 25 °C	-	60	V
$V_{GS}$	gate-source voltage	T <sub>amb</sub> = 25 °C	-	±20	V
ID	drain current	V <sub>GS</sub> = 10 V	[1]		
		T <sub>amb</sub> = 25 °C	-	350	mA
		$T_{amb} = 100 \ ^{\circ}C$	-	245	mA
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \leq$ 10 $\mu s$	-	1.2	A

In accorda	ance with the Absolute Ma	ximum Rating System (IE	C 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>tot</sub> total power dissipation	total power dissipation	T <sub>amb</sub> = 25 °C	[2] -	370	mW
		[1] -	440	mW	
		T <sub>sp</sub> = 25 °C	-	1.2	W
Tj	junction temperature			150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C
Source-d	rain diode				
ls	source current	T <sub>amb</sub> = 25 °C	<u>[1]</u> -	350	mA
ESD maximum rating					
$V_{\text{ESD}}$	electrostatic discharge voltage	human body model	<u>[3]</u> _	2000	V

#### Table 5. Limiting values ... continued

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



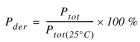
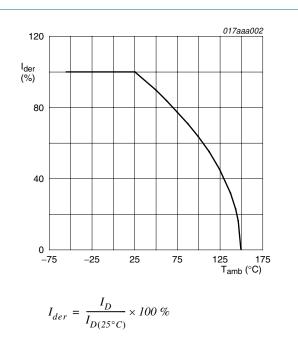


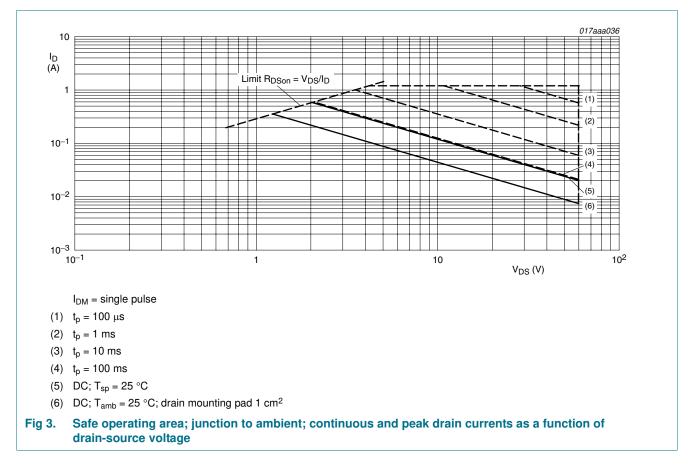
Fig 1. Normalized total power dissipation as a function of ambient temperature





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## 6. Thermal characteristics

#### Table 6.Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R <sub>th(j-a)</sub> thermal resistance from junction to ambient	thermal resistance from	in free air	<u>[1]</u> -	295	340	K/W
	junction to ambient		[2] _	250	285	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	105	K/W

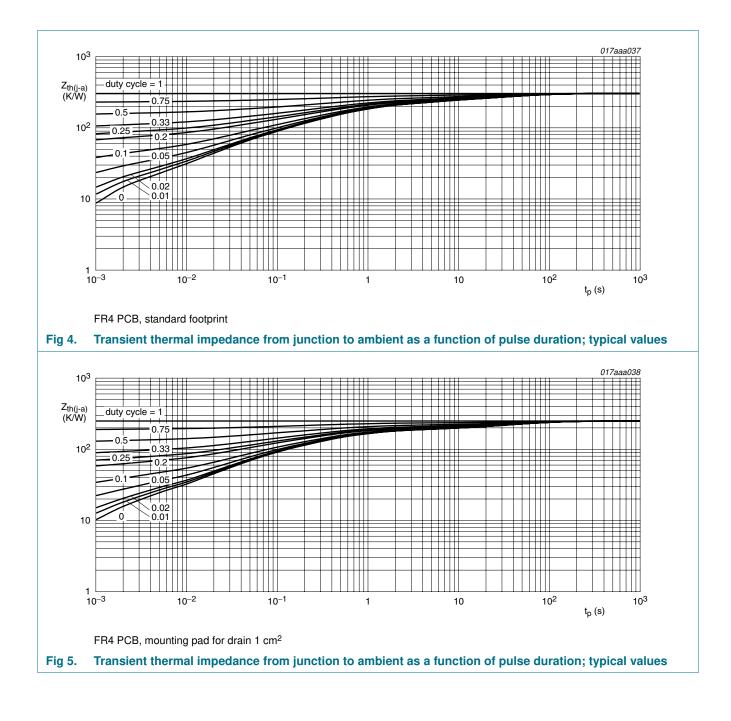
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.

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## 7. Characteristics

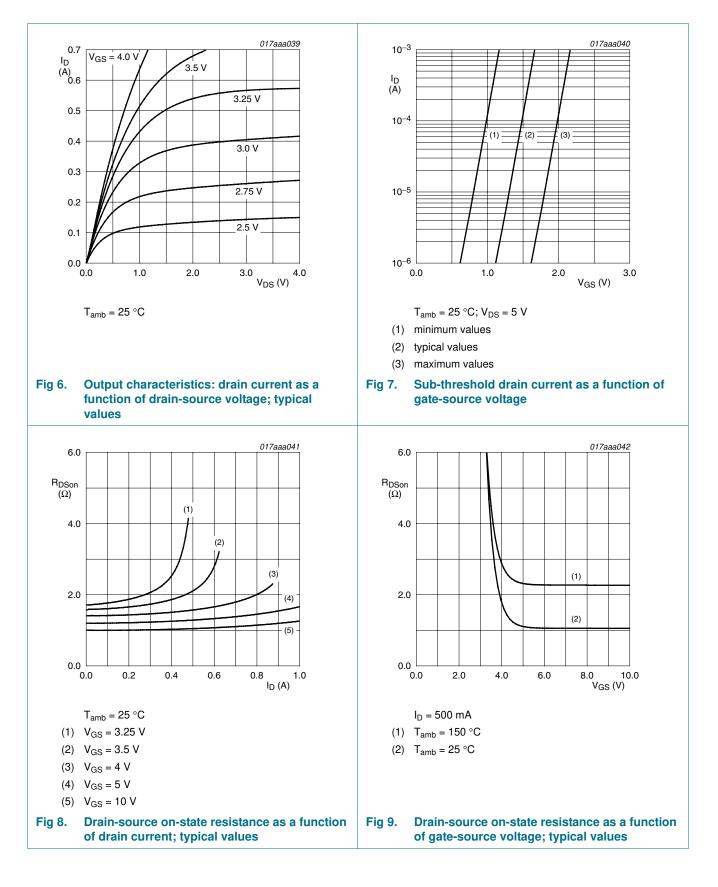
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D=10~\mu\text{A};~V_{GS}=0~V$	60	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 250 \ \mu\text{A}; \ V_{DS} = V_{GS}$	1.1	1.6	2.1	V
I <sub>DSS</sub> o	drain leakage current	$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}$				
		T <sub>j</sub> = 25 °C	-	-	1	μA
		T <sub>j</sub> = 150 °C	-	-	10	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}=\pm 20~V;~V_{DS}=0~V$	-	-	10	μA
DOOII	drain-source on-state		<u>[1]</u>			
	resistance	$V_{GS}$ = 5 V; $I_D$ = 50 mA	-	1.3	2	Ω
		$V_{GS}$ = 10 V; I <sub>D</sub> = 500 mA	-	1	1.6	Ω
9fs	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 200 \text{ mA}$	<u>[1]</u> _	550	-	mS
Dynamic of	characteristics					
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 300 mA;	-	0.5	0.6	nC
Q <sub>GS</sub>	gate-source charge	V <sub>DS</sub> = 30 V; V <sub>GS</sub> = 4.5 V	-	0.2	-	nC
Q <sub>GD</sub>	gate-drain charge	$V_{GS} = 4.5 V$	-	0.1	-	nC
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 V; V_{DS} = 10 V;$	-	33	50	pF
C <sub>oss</sub>	output capacitance	f = 1 MHz	-	7	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	4	-	pF
t <sub>d(on)</sub>	turn-on delay time	V <sub>DD</sub> = 50 V;	-	5	10	ns
t <sub>r</sub>	rise time	R <sub>L</sub> = 250 Ω; - V <sub>GS</sub> = 10 V;	-	6	-	ns
t <sub>d(off)</sub>	turn-off delay time	$R_{G} = 6 \Omega$	-	12	24	ns
t <sub>f</sub>	fall time		-	7	-	ns
Source-dr	ain diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 115 mA; V <sub>GS</sub> = 0 V	0.47	0.75	1.1	V

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#### 60 V, 350 mA N-channel Trench MOSFET

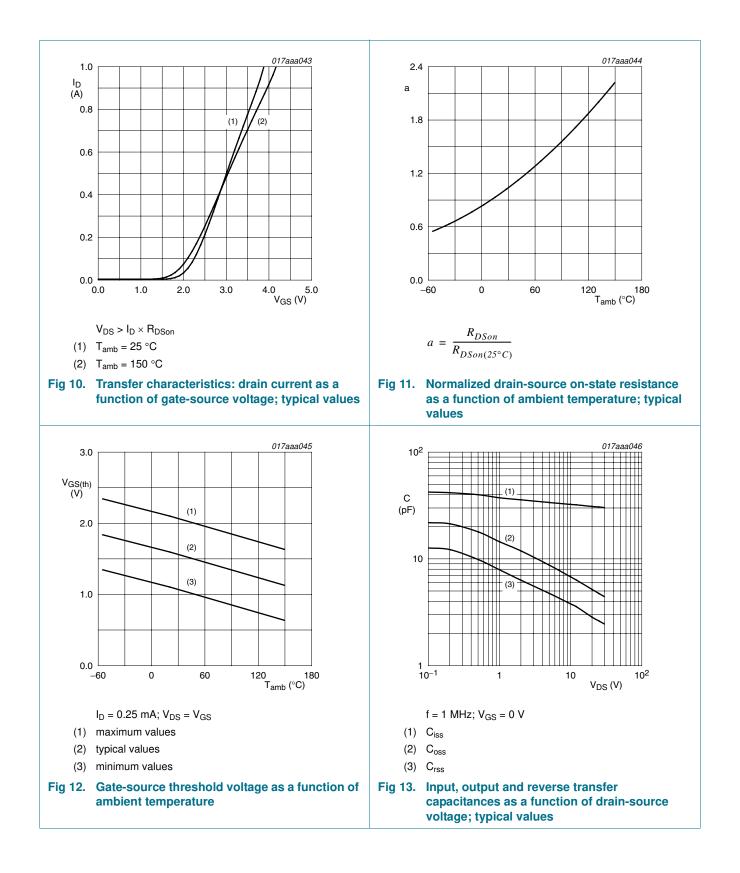


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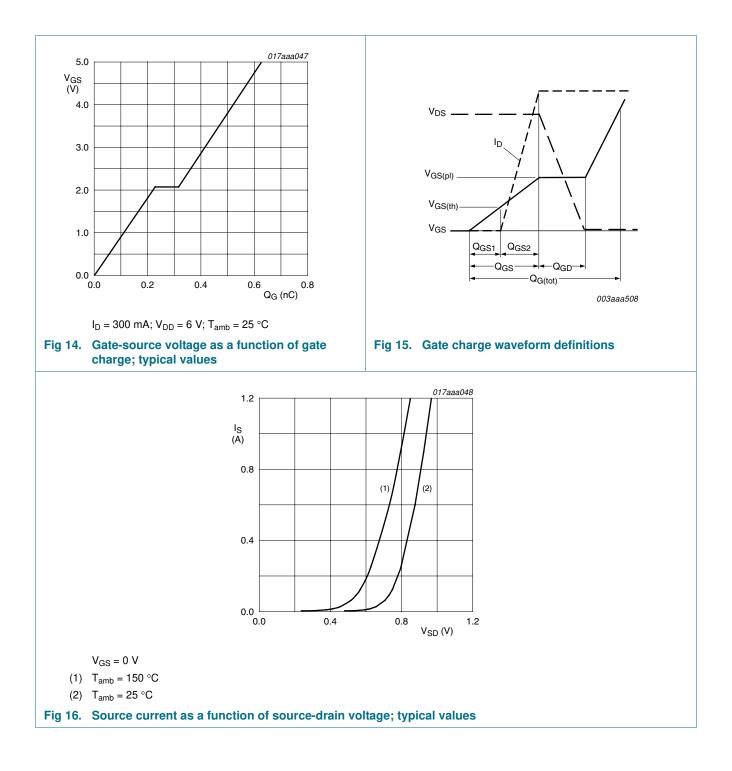
#### 60 V, 350 mA N-channel Trench MOSFET



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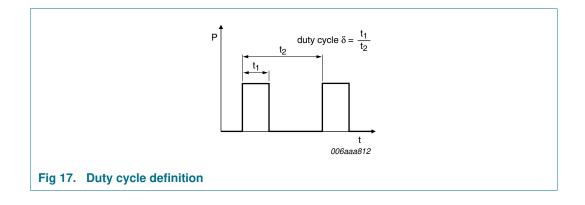
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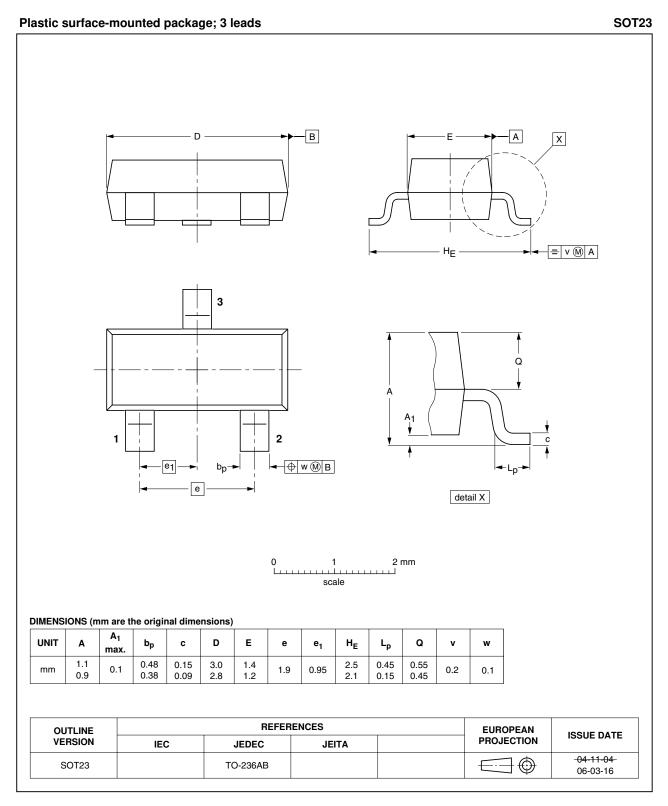
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## 8. Test information



60 V, 350 mA N-channel Trench MOSFET

## 9. Package outline

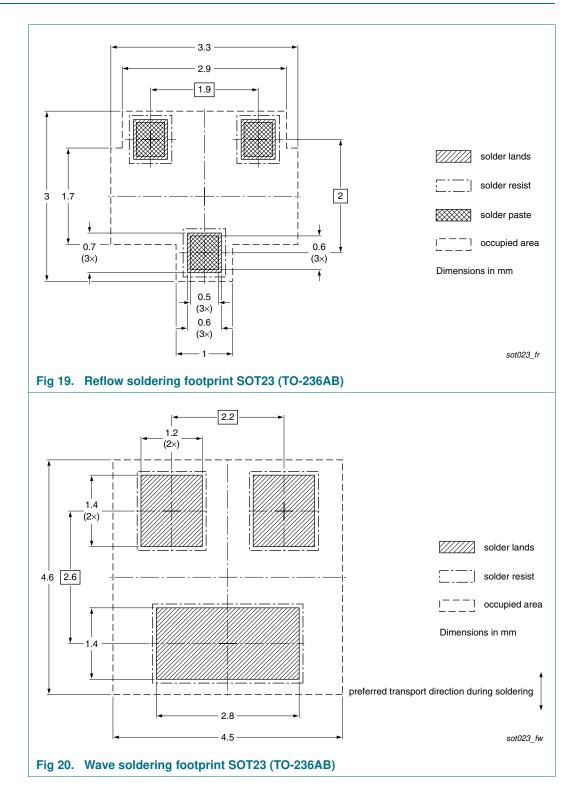


#### Fig 18. Package outline SOT23 (TO-236AB)

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#### 60 V, 350 mA N-channel Trench MOSFET

## **10. Soldering**



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## **11. Revision history**

Table 8. Revision h	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
2N7002BK v.1	20100617	Product data sheet	-	-		

#### 60 V, 350 mA N-channel Trench MOSFET

## 12. Legal information

### 12.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

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